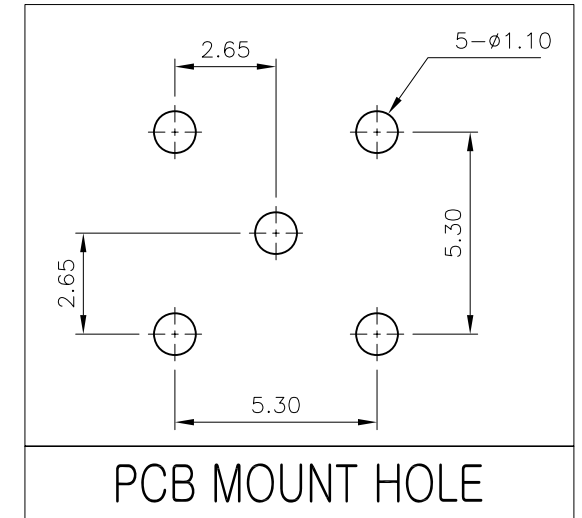
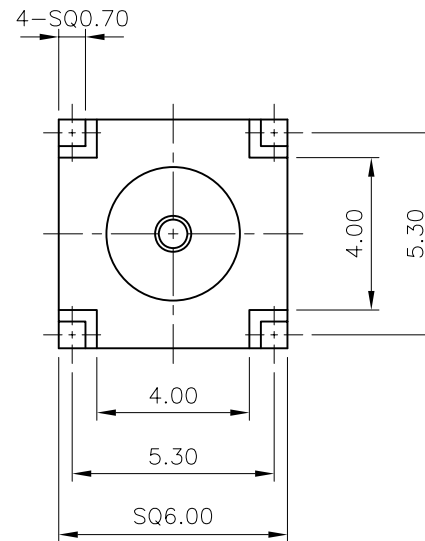
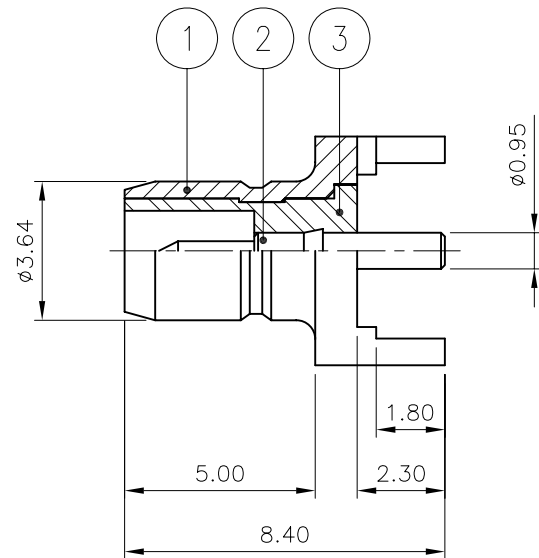


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2014.08.07.



NOTE

★★★ 1. 도금 사양

-BODY : 하지 Ni 5 μ m 이상

Gold 0.06 μ m 이상

-CONTACT : 하지 Ni 5 μ m 이상

Gold 1.27 μ m 이상

3	INSULATOR	1	TEFLON		DIN02397-N/1
2	CONTACT	1	MBsBD	Note 참조	DCT03193-5/1
1	BODY	1	MBsBD	Note 참조	DBD03689-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2014. 08. 07.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY		
MATERIAL		CHECKED BY		TITLE SMB50 PCB JS-4R
		DRAWN BY	I.C.KIM	
FINISH		SCALE	5/1	A4 DWG NO. CN03232-7/2 REVISION I R SHEET 1 of 1
		UNIT	mm	